

**PATENT ASSIGNMENT**

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Hitoshi Kida	06/28/2006
Takahiro Yamada	06/28/2006
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Ricoh Printing Systems, Ltd.
<b>Street Address:</b>	No. 15-1, Konan 2-chome, Minato-ku
<b>City:</b>	Tokyo
<b>State/Country:</b>	JAPAN
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	11427502
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(703)787-7557
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
<b>Phone:</b>	703-787-9400
<b>Email:</b>	linda@wcc-ip.com
<b>Correspondent Name:</b>	Whitham, Curtis, Christofferson & Cook
<b>Address Line 1:</b>	11491 Sunset Hills Road, Suite 340
<b>Address Line 4:</b>	Reston, VIRGINIA 20190
<b>ATTORNEY DOCKET NUMBER:</b>	03280111AA
<b>NAME OF SUBMITTER:</b>	Marshall M. Curtis
<b>Total Attachments: 2</b>	
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CH \$40.00 11427502

# ASSIGNMENT OF APPLICATION FOR PATENT

WHEREAS

NAME AND ADDRESS  
OF ASSIGNOR(S)

Hitoshi KIDA, and  
Takahiro YAMADA

of

Hitachinaka-shi, Ibaraki-ken, Japan

(HEREINAFTER REFERRED TO AS ASSIGNOR), have  
invented and own a certain invention  
entitled:

TITLE OF INVENTION:

METHOD OF EJECTING MICRODROPLETS OF INK

for which application for Letters Patent of  
the United States has been executed on even  
date herewith,

WHEREAS

FULL NAME AND ADDRESS  
OF ASSIGNEE

RICOH PRINTING SYSTEMS, LTD.  
No.15-1, Konan 2-chome, Minato-ku, Tokyo, Japan

(hereinafter referred to as ASSIGNEE), is  
desirous of acquiring the entire interest  
in, to and under said invention and the United  
States Letters Patent to be obtained  
therefor:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN:  
Be it known that in consideration of the  
payment of ASSIGNEE to ASSIGNOR of the sum  
of One Dollar (\$1.00), the receipt of which  
is hereby acknowledged, and for other good  
and valuable consideration, ASSIGNOR hereby  
sells, assigns and transfers to ASSIGNEE the

full and exclusive right, title and interest to said invention and all Letters Patent of the United States to be obtained therefor on said application or any continuation, division, renewal, substitute or reissue thereof for the full term or terms for which the same may be granted.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE or its legal representative any and all papers, instruments or affidavits required to apply for, obtain, maintain and enforce said application, said invention and said Letters Patent which may be necessary or desirable to carry out the purposes hereof.

Jun. 28, 2006  
DATE OF SIGNING

Hitoshi Kida  
SIGNATURE/ Hitoshi KIDA

Jun. 28, 2006  
DATE OF SIGNING

Takahiro Yamada  
SIGNATURE/ Takahiro YAMADA

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